# Connector for microSD™ Card (Push-push Type)

**SCHA** Series



## Compact low-profile type most suitable for mobile phones.

For SD Memory Card

#### For microSD™ Card

For SIM Card 8pins

For W-SIM

For Memory Stick Micro™

For Memory Stick™

Combine Type

For Compact Flash™

For CMOS Camera Module

NEW	A A CONTRACTOR OF THE PARTY OF
	Specie Control of the

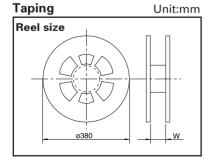
Typical Specifications

	Items		Specifications		
Structure -	Applicable media		microSD™ Card		
	Mounting type		Surface mounting type		
	Mounting style		Standard mount/ Reverse mount		
	Media ejection structure		Push-push type		
Performance	Operating temperature range		−20°C to +70°C		
	Voltage proof		500V AC 1minute		
	Insulation resistance (Initial)		1,000M $\Omega$ min.		
	Contact resistance (Initial)	Connector contacts	100mΩ max.		
		Detection switch	500mΩ max.		
	Insertion and removal cycle		5,000cycles		

#### Product Line

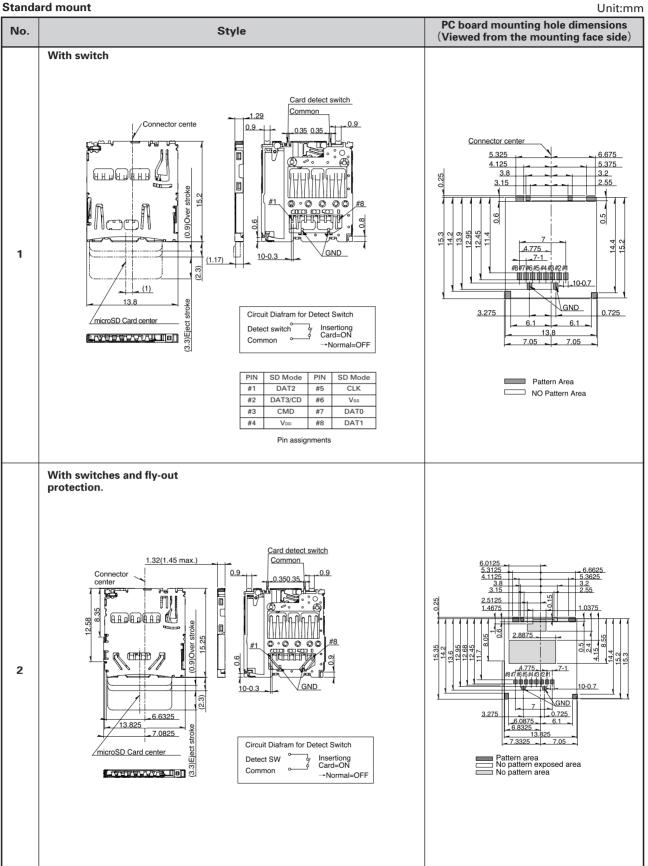
Media ejection structure	Mounting system	Features	Stand-off (mm)	Packing system	Product No.	Drawing No.
Push-push type	Standard mount	With switch	0	Taping	SCHA4B0100	1
		With switches and fly-out protection.			SCHA4B0400	2
	Reverse mount	With switch			SCHA5B0200	3

### Packing Specifications



Product	Number of packages (pcs.)			Reel width	Tape width	Export package	
No.	1 reel	1 case /Japan	1 case /export packing	W (mm)	(mm)	measurements (mm)	
SCHA4B0100	2,000	6,000	12,000				
SCHA4B0400	2,000	0,000	12,000	24.4	24	403×403× 249	
SCHA5B0200	1.500	4.500	9.000				

## Dimensions



SD Memory Card

#### For microSD™ Card

For SIM Card 8pins

For W-SIM

For Memory Stick Micro™

For Memory Stick™

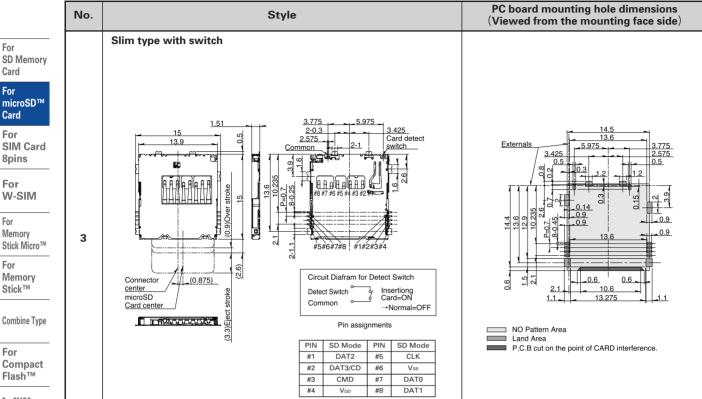
Combine Type

For Compact Flash™

For CMOS Camera Module

### Dimensions **Reverse mount**

Unit:mm



SD Memory Card

For microSD™ Card

For SIM Card 8pins

W-SIM

Memory Stick Micro™

Memory Stick™

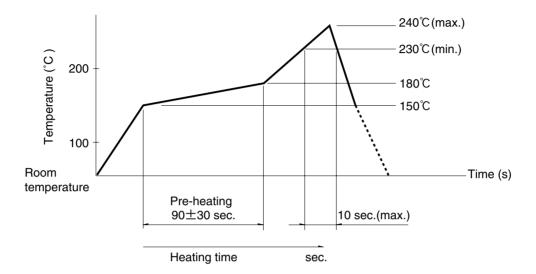
For Compact Flash™

For CMOS Camera Module

# **Soldering Conditions**

### **Example of Reflow Soldering Condition (Reference)**

- 1. Heating method: Double heating method with infrared heater.
- 2. Temperature measurement: Thermocouple 0.1 to 0.2  $\phi$  CA (K) or CC (T).
- 3. Temperature profile (Surface of products).



### SD Memory Card

For microSD™ Card

For SIM Card 8pins

For W-SIM

For Memory Stick Micro™

For Memory Stick™

Combine Type

### For Compact Flash™

For CMOS Camera Module

# **Cautions for using this product**

- 1. When soldering terminals, there is a danger that load placed on the terminals may cause rattle, deformation or electrical degradation to occur depending on the conditions. Caution is therefore required.
- 2. Avoid use of water-soluble soldering flux, since it may corrode the product.
- 3. Check and conform to reflow soldering requirements under actual mass production conditions.
- 4. PC board warping may alter the characteristics. Please take this into consideration when designing patterns and layout.
- 5. The card specifications are provided by the above manufactures. Products by other manufactures may not be compliant with these specifications and are subject to change without prior notice.

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

## ALPS:

SCHA5B0200 SCHA1B0100 SCHA4B0100 SCHA1A0101 SCHA2B0300